



IFW

PATENT
8001-1158-1

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Rieka OHUCHI

Conf. 3792

Application No. 10/659,383

Group 2812

Filed September 11, 2003

SEMICONDUCTOR DEVICE AND METHOD
OF MANUFACTURING THEREOFSUPPLEMENTAL INFORMATION DISCLOSURE STATEMENTCommissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

August 10, 2004

Sir:

In compliance with Rules 1.97 and 1.98, and in fulfillment of the duty of disclosure under Rule 1.56, the accompanying documents, copies of which are attached to this statement, are made of record on the enclosed Form PTO-1449.

A concise explanation of the relevance of these items is that these references were cited by the Japanese Patent Office in an Official Action. A copy of the Japanese Official Action in which they were cited is attached hereto, with what is believed to be the pertinent portion enclosed in a wavy line. **An English translation of the enclosed portion is also attached hereto.**

Respectfully submitted,

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